



UCC28600

SLUS646B-NOVEMBER 2005-REVISED MAY 2006

8-PIN QUASI-RESONANT FLYBACK GREEN MODE CONTROLLER

FEATURES

- Green Mode Controller With Advanced Energy Saving Features
- Quasi-Resonant Mode Operation for Reduced EMI and Low Switching Losses (Low Voltage Switching)
- Low Standby Current for System No-Load Power Consumption to 150 mW
- Low Startup Current: 25 µA Maximum
- Programmable Overvoltage Protection, Line
 and Load
- Internal Overtemperature Protection: Prevents Restart Until Temperature Fault Cleared
- Current Limit Protection
 - Cycle-by-Cycle Power Limit
 - Overcurrent Hiccup Restart Mode
- 1-A Sink TrueDrive™, -0.75-A Source Gate Drive Output
- Programmable Soft-Start
- Greenmode STATUS pin (PFC Disable Function)

TYPICAL APPLICATION

APPLICATIONS

- Bias Supplies for LCD-Monitors, LCD-TV, PDP-TV, and Set Top Boxes
- AC/DC Adapters and Offline Battery Chargers
- Energy Efficient Power Supplies up to 200 W

DESCRIPTION

The UCC28600 is a PWM controller with advanced energy features to meet stringent world-wide energy efficiency requirements.

UCC28600 integrates built-in advanced energy saving features with high level protection features to provide cost effective solutions for energy efficient power supplies. UCC28600 incorporates frequency fold back and burst mode operation to reduce the operation frequency at light load and no load operations.

UCC28600 is offered in the 8-pin SOIC (D) package. Operating temperature range is -40°C to 105°C.



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ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

			UCC28600	UNIT
V _{DD}	Supply voltage range	I _{DD} < 20 mA	32	V
I _{DD}	Supply current		20	mA
I _{OUT(sink)}	Output sink current (peak)		1.2	٨
I _{OUT(source)}	Output source current (peak)		-0.8	A
	Analog inputs	FB, CS, SS	-0.3 to 6.0	V
V _{OVP}			-1.0 to 6.0	v
I _{OVP(source)}			-1.0	mA
V _{STATUS}		VDD = 0 V to 30 V	30	V
	Power dissipation	SOIC-8 package, $T_A = 25^{\circ}C$	650	mW
TJ	Operating junction temperature	re range	-55 to 150	
T _{stg}	Storage temperature		-65 to 150	°C
T _{LEAD}	Lead temperature 1,6 mm (1/	16 inch) from case for 10 seconds	300	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltages are with respect to GND. Currents are positive into, negative out of the specified terminal. Consult Packaging Section of the databook for thermal limitations and considerations of packages.

RECOMMENDED OPERATING CONDITIONS

		MIN	NOM	MAX	UNIT
V_{DD}	Input voltage			21	V
I _{OUT}	Output sink current	0			А
TJ	Operating junction temperature	-55		150	°C

ELECTROSTATIC DISCHARGE (ESD) PROTECTION

	MIN	MAX	UNIT
Human body model		2000	V
CDM		1500	v

ELECTRICAL CHARACTERISTICS

VDD = 15 V, 0.1- μ F capacitor from VDD to GND, 3.3-nF capacitor from SS to GND charged over 3.5 V, 500- Ω resistor from OVP to -0.1 V, FB = 4.8 V, STATUS = not connected, 1-nF capacitor from OUT to GND, CS = GND, T_A = T_J = -40°C to 105°C, (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Overall			1			
I _{STARTUP}	Startup current	$V_{DD} = V_{UVLO} - 0.3 V$		12	25	
I _{STANDBY}	Standby current	V _{FB} = 0 V		350	550	μΑ
	O	Not switching		2.5	3.5	
DD	Operating current	130 kHz, QR mode		5.0	7.0	MA
	VDD clamp	$FB = GND$, $I_{DD} = 10 mA$	21	26	32	V
Undervolt	age Lockout					
V _{DD(uvlo)}	Startup threshold		10.3	13.0	15.3	
	Stop threshold		6.3	8	9.3	V
	Hysteresis		4.0	5.0	6.0	
PWM (Ran	mp) ⁽¹⁾					
D _{MIN}	Minimum duty cycle	$V_{SS} = GND, V_{FB} = 2 V$			0%	
D _{MAX}	Maximum duty cycle	QR mode, f _S = max, (open loop)		99%		
Oscillator	(OSC)		1			
f _{QR(max)}	Maximum QR frequency		117	130	143	
f _{QR(min)}	Minimum QR and FFM frequency	V _{FB} = 1.3 V	32	40	48	kHz
f _{SS}	Soft start frequency	V _{SS} = 2.0 V	32	40	48	
dT _S /dFB	VCO gain	T _S for 1.6 V < V _{FB} < 1.8 V	-38	-30	-22	μs/V
Feedback	(FB)					
	Feedback pullup resistor		12	20	28	kΩ
	FB, no load	QR mode	3.30	4.87	6.00	
	Green mode ON threshold	V _{FB} threshold	0.3	0.5	0.7	
	Green mode OFF threshold	V _{FB} threshold	1.2	1.4	1.6	
	Green mode hysteresis	V _{FB} threshold	0.7	0.9	1.1	V
	FB threshold burst-ON	V _{FB} during Green mode	0.3	0.5	0.7	
	FB threshold burst-OFF	V _{FB} during Green mode	0.5	0.7	0.9	
	Burst Hysteresis	V _{FB} during Green mode	0.13	0.25	0.42	
Status		· · · · · · · · · · · · · · · · · · ·	"			
	STATUS R _{DS(on)}	V _{STATUS} = 1 V	1.0	2.4	3.8	kΩ
	STATUS leakage/off current	V _{FB} = 0.44 V, V _{STATUS} = 15 V	-0.1		2.0	μA

(1) R_{SCT} and C_{CST} are not connected in the circuit for maximum and minimum duty cycle tests, current sense tests and power limit tests.

ELECTRICAL CHARACTERISTICS (continued)

VDD = 15 V, 0.1- μ F capacitor from VDD to GND, 3.3-nF capacitor from SS to GND charged over 3.5 V, 500- Ω resistor from OVP to -0.1 V, FB = 4.8 V, STATUS = not connected, 1-nF capacitor from OUT to GND, CS = GND, T_A = T_J = -40°C to 105°C, (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Current S	ense (CS) ⁽²⁾					
A _{CS(FB)}	Gain, FB = $\Delta V_{FB} / \Delta V_{CS}$	QR mode		2.5		V/V
	Shutdown threshold	V _{FB} = 2.4 V, V _{SS} = 0 V	1.13	1.25	1.38	V
	CS to output delay time (power limit)	CS = 1.0 V _{PULSE}	100	175	300	
	CS to output delay time (over current fault)	$CS = 1.45 V_{PULSE}$	50	100	150	ns
	CS discharge impedance	CS = 0.1 V, V _{SS} = 0 V	25	115	250	Ω
	CS offset	SS mode, V _{SS} ≤ 2.0 V, via FB	0.35	0.40	0.45	V
Power Lir	nit (PL) ⁽²⁾					
	CS current	OVP = -300 μA	-165	-150	-135	μA
	CS working range	QR mode, peak CS voltage	0.70	0.81	0.92	V
	PL threshold	Peak CS voltage + CS offset	1.05	1.20	1.37	v
Soft Start	(SS)					
I _{SS(chg)}	Softstart charge current	V _{SS} = GND	-8.3	-6.0	-4.5	μA
I _{SS(dis)}	Softstart discharge current	V _{SS} = 0.5 V	2.0	5.0	10	mA
V _{SS}	Switching ON threshold	Output switching start	0.8	1.0	1.2	V
Overvolta	ge Protection (OVP)					
OVP _(line)	Line overvoltage protection	I_{OVP} threshold, OUT = HI	-512	-450	-370	μA
	OVP voltage at OUT = HIGH	V_{FB} = 4.8 V, V_{SS} = 5.0 V, $I_{OVP},$ = -300 μA	-125		-25	mV
OVP _(load)	Load overvoltage protection	V_{OVP} threshold, OUT = LO	3.37	3.75	4.13	V
Thermal F	Protection (TSD)					
	Thermal shutdown (TSP) temperature ⁽³⁾		130	140	150	ŝ
	Thermal shutdown hysteresis			15		0
OUT						
t _{RISE}	Rise time	10% to 90% of 13 V typical out clamp		50	75	20
t _{FALL}	Fall time			10	20	115

R_{SCT} and C_{CST} are not connected in the circuit for maximum and minimum duty cycle tests, current sense tests and power limit tests.
 (3) Ensured by design. Not production tested.





NOTE:

 R_{CST} and C_{CST} are not connected for maximum and minimum duty cycle tests, current sense tests and power limit tests.



BLOCK DIAGRAM/TYPICAL APPLICATION

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ORDERING INFORMATION

T _A	PACKAGES	PART NUMBER
-40°C to 105°C	SOIC (D) ⁽¹⁾	UCC28600D

(1) SOIC (D) package is available taped and reeled by adding "R" to the above part numbers. Reeled quantities for UCC28600DR is 2,500 devices per reel.

DEVICE INFORMATION



TERMINAL FUNCTIONS

TERMI	TERMINAL		
NAME	NO.	1/0	DESCRIPTION
cs	3	I	Current sense input. Also programs power limit, and used to control modulation and activate overcurrent protection. The CS voltage input originates across a current sense resistor and ground. Power limit is programmed with an effective series resistance between this pin and the current sense resistor.
FB	2	 Feedback input or control input from the optocoupler to the PWM comparator used to control the pea in the power MOSFET. An internal 20-kΩ resistor is between this pin and the internal 5-V regulated v Connect the collector of the photo-transistor of the feedback optocoupler directly to this pin; connect the emitter of the photo-transistor to GND. The voltage of this pin controls the mode of operation in one of three modes: quasi resonant (QR), frequency foldback mode (FFM) and green mode (GM). 	
GND	4	-	Ground for internal circuitry. Connect a ceramic 0.1-µF bypass capacitor between VDD and GND, with the capacitor as close to these two pins as possible.
OUT	5	0	1-A sink (TrueDrive [™]) and 0.75-A source gate drive output. This output drives the power MOSFET and switches between GND and the lower of VDD or the 13-V internal output clamp.
OVP	7	I	Over voltage protection (OVP) input senses line-OVP, load-OVP and the resonant trough for QR turn-on. Detect line, load and resonant conditions using the primary bias winding of the transformer, adjust sensitivity with resistors connected to this pin.
SS	1	I	Soft-start programming pin. Program the soft-start rate with a capacitor to ground; the rate is determined by the capacitance and the internal soft-start charge current. All faults discharge the SS pin to GND through an internal MOSFET with an $R_{DS(on)}$ of approximately 100 Ω . The internal modulator comparator reacts to the lowest of the SS voltage, the internal FB voltage and the peak current limit. Typically, T_{SS} = 1.5 ms for C_{SS} = 3.3 nF.
STATUS	8	0	ACTIVE HIGH open drain signal that indicates the device has entered standby mode. This pin can be used to disable the PFC control circuit (high impedance = green mode). STATUS pin is high during UVLO, (V_{DD} < startup threshold), and softstart, (SS < FB).
VDD	6	I	Provides power to the device. Use a ceramic 0.1-µF by-pass capacitor for high-frequency filtering of the VDD pin, as described in the GND pin description. Operating energy is usually delivered from auxiliary winding. To prevent hiccup operation during start-up, a larger energy storage cap is also needed between VDD and GND.



TERMINAL COMPONENTS

TERMINAL		2/2		
NAME	NO.	1/0		
CS	3	1	$\begin{split} R_{CS} &= \frac{\left(V_{PL} - V_{CS(os)}\right) \left(I_{CS(2)} - I_{CS(1)}\right)}{I_{CS(2)} I_{P(1)} - I_{CS(1)} I_{P(2)}} \\ R_{PL} &= \frac{\left(V_{PL} - V_{CS(os)}\right) \left(I_{P(2)} - I_{P(1)}\right)}{I_{CS(1)} I_{P(2)} - I_{CS(2)} I_{P(1)}} \\ \end{split} \\ \\ where: \\ \bullet I_{P1} \text{ is the peak primary current at low line, full load} \\ \bullet I_{P2} \text{ is the peak primary current at high line, full load} \\ \bullet I_{CS1} \text{ is the power limit current that is sourced at the CS pin at low-line voltage} \\ \bullet I_{CS2} \text{ is the power limit current that is sourced at the CS pin at high-line voltage} \\ \bullet V_{PL} \text{ is the Power Limit (PL) threshold} \\ \bullet V_{CS(os)} \text{ is the CS offset voltage} \end{split}$	
FB	2	Ι	Opto-isolator collector	
GND	4	-	Bypass capacitor to VDD, $C_{BP} = 0.1 \ \mu F$	
OUT	5	0	Power MOSFET gate	
OVP	7	I	$\begin{split} R_{OVP1} &= \frac{1}{I_{OVP(lineth)}} \left(\frac{N_B}{N_P} V_{BULK(ov)} \right) \\ R_{OVP2} &= R_{OVP1} \left\{ \frac{V_{OVP(load th)}}{\frac{N_B}{N_S} (V_{OUT(ov)} + V_F) - V_{OVP(load th)}} \right) \\ \end{split}$ where: $ I_{OVP(line th)} \text{ is OVP}_{line} \text{ current threshold} \\ V_{BULK(ov)} \text{ is the allowed input over- voltage level} \\ V_{OVP(load_th)} \text{ is OVP}_{load} \\ V_{OUT(ov)} \text{ is the allowed output over-voltage level} \\ V_F \text{ is the forward voltage of the secondary rectifier} \\ N_B \text{ is the number of turns on the bias winding} \\ N_S \text{ is the number of turns on the primary windings} \\ N_P \text{ is the number of turns on the primary windings} \end{split}$	

(1) (2)

Refer to Figure 1 for all reference designators in the Terminal Components Table. Refer to the Electrical Characteristics Table for constant parameters. Refer to the UCC28600 Design Calculator (TI Literature Number SLVC104) or laboratory measurements for currents, voltages and times (3) in the operational circuit.

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TERMINAL	. COMPONENTS	(continued)	
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TERMINAL		1/0			
NAME	NO.	1/0			
			$C_{SS} > I_{SS} \times \frac{t_{SS(min)}(\text{due power limit})}{A_{CS(FB)} \times \left(V_{PL} - V_{CS(os)}\right)}$		
SS	1	I	where $t_{SS(min)}$ is the greater of: $t_{SS(min)} = \left[\frac{-R_{OUT(SS)}C_{OUT}}{2} \ell n \left[1 - \frac{\left(V_{OUT} - \Delta V_{OUT(step)}\right)^2}{R_{OUT(SS)}P_{LIM}} \right] \right]$ or $t_{SS(min)} = \left[\frac{C_{OUT}V_{OUT}^2}{2P_{LIM}} \right]$ • $R_{OUT(SS)}$ is the effective load impedance during soft-start • $\Delta V_{OUT(step)}$ is the effective load impedance during soft-start • $\Delta V_{OUT(step)}$ is the allowed change in V_{OUT} due to a load step • P_{LIM} is the programmed power limit level, in W • $A_{CS(FB)}$ is the current sense gain. • $V_{CS(oS)}$ is the CS offset voltage		
STATUS	8	0	$\begin{split} R_{ST2} &= \frac{V_{BE(off)}}{I_{STATUS(leakage)}} \\ R_{ST1} &= \frac{R_{ST2} \times \left[V_{DD(uvlo-on)} - V_{BE(sat)} - R_{DS(on)} \times \left(\frac{I_{CC}}{\beta_{sat}} \right) \right] - R_{DS(on)} V_{BE(sat)}}{\left(\left(\frac{I_{CC}}{\beta_{sat}} \right) \times R_{ST2} \right) + V_{BE(sat)}} \\ \end{split}$ where: • β_{SAT} is the gain of transistor Q_{ST} in saturation • $V_{BE(sat)}$ is the base-emitter voltage of transistor Q_{ST} in saturation • $V_{DD(uvlo-on)}$ is the startup threshold • I_{CC} is the collector current of Q_{ST} • $I_{STATUS(leakage)}$ is the maximum leakage/off current of the STATUS pin • $V_{BE(off)}$ is the maximum allowable voltage across the base emitter junction that will not turn Q_{ST} on • $R_{DS(on)}$ is the $R_{DS(on)}$ of STATUS		

TEDMINIAL			
IERMI	NAL	I/O	DESCRIPTION ⁽¹⁾⁽²⁾⁽³⁾
NAME	NO.		
VDD	6	I	
VDD	6	1	$\begin{split} R_{DD} &= \left(\frac{\pi}{4}\right) \left(\frac{N_{B}}{N_{P}}\right) \left[\frac{\left(\frac{V_{DS1(os)} {}^{T}_{QR(max)} \sqrt{L_{LEAKAGE}} (C_{D} + C_{SNUB})}{I_{DD} + C_{ISS} V_{OUT(hi)} {}^{T}_{QR(max)}}\right] \\ R_{SU} &= \frac{V_{BULK(min)}}{I_{STARTUP}} \\ \end{split} \\ \\ $

TERMINAL COMPONENTS (continued)



Figure 1. Pin Termination Schematic



APPLICATION INFORMATION

Functional Description

The UCC28600 is a multi-mode controller, as illustrated in Figure 3 and Figure 4. The mode of operation depends upon line and load conditions. Under all modes of operation, the UCC28600 terminates the OUT = HI signal based on the switch current. Thus, the UCC28600 always operates in current mode control so that the power MOSFET current is always limited.

Under normal operating conditions, the FB pin commands the operating mode of the UCC28600 at the voltage thresholds shown in Figure 2. Soft-start and fault responses are the exception. Soft-start mode hard-switch controls the converter at 40 kHz. The soft-start mode is latched-OFF when V_{FB} becomes less than V_{SS} for the first time after UVLO_{ON}. The soft-start state cannot be recovered until after passing UVLO_{OFF}, and then, UVLO_{ON}.

At normal rated operating loads (from 100% to approximately 30% full rated power) the UCC28600 controls the converter in quasi-resonant mode (QRM) or discontinuous conduction mode (DCM), where DCM operation is at the clamped maximum switching frequency (130 kHz). For loads that are between approximately 30% and 10% full rated power, the converter operates in frequency foldback mode (FFM), where the peak switch current is constant and the output voltage is regulated by modulating the switching frequency. Effectively, operation in FFM results in the application of constant volt-seconds to the flyback transformer each switching cycle. Voltage regulation in FFM is achieved by varying the switching frequency in the range from 130 kHz to 40 kHz. For extremely light loads (below approximately 10% full rated power), the converter is controlled using bursts of 40-kHz pulses. Keep in mind that the aforementioned boundaries of steady-state operation are approximate because they are subject to converter design parameters.

Refer to the typical applications block diagram for the electrical connections to implement the features.



Figure 2. Mode Control with FB Pin Voltage



Figure 3. Control Flow Chart







Details of the functional boxes in the Block Diagram/Typical Application drawing are shown in Figure 5, Figure 6, Figure 7 and Figure 8. These figures conceptualize how the UCC28600 executes the command of the FB voltage to have the responses that are shown in Figure 2, Figure 3 and Figure 4. The details of the functional boxes also conceptualize the various fault detections and responses that are included in the UCC28600. During all modes of operation, this controller operates in current mode control. This allows the UCC28600 to monitor the FB voltage to determine and respond to the varying load levels such as heavy, light or ultra-light.

Quasi-resonant mode and DCM occurs for feedback voltages V_{FB} between 2.0 V and 4.0 V, respectively. In turn, the CS voltage is commanded to be between 0.4 V and 0.8 V. A cycle-by-cycle power limit imposes a fixed 0.8-V limit on the CS voltage. An overcurrent shutdown threshold in the fault logic gives added protection against shorted winding faults, shown in Figure 8. The power limit feature in the QR DETECT circuit of Figure 7 adds an offset to the CS signal that is proportional to the line voltage. The power limit feature is programmed with R_{PI} , as shown in the typical applications diagram.



Figure 5. Oscillator Details



Figure 6. Mode Clamp Details

-0





Figure 7. QR Detect Details



Figure 8. Fault Logic Details

Quasi-Resonant / DCM Control

Quasi-resonant (QR) and DCM operation occur for feedback voltages V_{FB} between 2.0 V and 4.0 V. In turn, the peak CS voltage is commanded to be between 0.4 V and 0.8 V. During this control mode, the rising edge of OUT always occurs at the valley of the resonant ring after demagnetization. Resonant valley switching is an integral part of QR operation. Resonant valley switching is also imposed if the system operates at the maximum switching frequency clamp. In other words, the frequency varies in DCM operation in order to have the switching event occur on the first resonant valley that occurs after a 7.7- μ s (130-kHz) interval. Notice that the CS pin has an internal dependent current source, 1/2 I_{LINE}. This current source is part of the cycle-by-cycle power limit function that is discussed in the Protection Features section.

Frequency Foldback Mode Control

Frequency foldback mode uses elements of the FAULT LOGIC, shown in Figure 8 and the mode clamp circuit, shown in Figure 6. At the minimum operating frequency, the internal oscillator sawtooth waveform has a peak of 4.0 V and a valley of 0.1 V. When the FB voltage is between 2.0 V and 1.4 V, the FB_CL signal in Figure 6 commands the oscillator in a voltage controlled oscillator (VCO) mode by clamping the peak oscillator voltage. The additional clamps in the OSCILLATOR restrict VCO operation between 40 kHz and 130 kHz. The FB_CL voltage is reflected to the modulator comparator effectively clamping the reflected CS command to 0.4 V.

Green Mode Control

Green mode uses element of the fault logic, shown in Figure 8 and the mode clamps circuit, shown in Figure 6. The OSC_CL signal clamps the Green mode operating frequency at 40 kHz. Thus, when the FB voltage is between 1.4 V and 0.5 V, the controller is commanding an excess of energy to be transferred to the load which in turn, drives the error higher and FB lower. When FB reaches 0.5 V, OUT pulses are terminated and do not resume until FB reaches 0.7 V. In this mode, the converter operates in hysteretic control with the OUT pulse terminated at a fixed CS voltage level of 0.4 V. The power limit offset is turned OFF during Green mode and it returns to ON when FB is above 1.4 V, as depicted in Figure 8. Green mode reduces the average switching frequency in order to minimize switching losses and increase the efficiency at light load conditions.

Fault Logic

Advanced logic control coordinates the fault detections to provide proper power supply recovery. This provides the conditioning for the thermal protection. Line overvoltage protection (line OVP) and load OVP are implemented in this block. It prevents operation when the internal reference is below 4.5 V. If a fault is detected in the thermal shutdown, line OVP, load OVP, or REF, the UCC28600 undergoes a shutdown/retry cycle.

Refer to the fault logic diagram in Figure 8 and the QR detect diagram in Figure 7 to program line OVP and load OVP. To program the load OVP, select the R_{OVP1} - R_{OVP2} divider ratio to be 3.75 V at the desired output shut-down voltage. To program line OVP, select the impedance of the R_{OVP1} - R_{OVP2} combination to draw 450 μ A when the V_{OVP} is 0.45 V during the ON-time of the power MOSFET at the highest allowable input voltage.

Oscillator

The oscillator, shown in Figure 5, is internally set and trimmed so it is clamped by the circuit in Figure 5 to a nominal 130-kHz maximum operating frequency. It also has a minimum frequency clamp of 40 kHz. If the FB voltage tries to drive operation to less than 40 kHz, the converter operates in green mode.

Status

The STATUS pin is an open drain output, as shown in Figure 8. The status output goes into the OFF-state when FB falls below 0.5 V and it returns to the ON-state (low impedance to GND) when FB rises above 1.4 V. This pin is used to control bias power for a PFC stage, as shown in Figure 9. Key elements for implementing this function include Q_{ST} , R_{ST1} and R_{ST2} , as shown in the figure. Resistors R_{ST1} and R_{ST2} are selected to saturate Q_{ST} when it is desirable for the PFC to be operational. During green mode, the STATUS pin becomes a high impedance and R_{ST1} causes Q_{ST} to turn-OFF, thus saving bias power. If necessary, use a zener diode and a resistor (D_{Z1} and R_{CC}) to maintain V_{CC} in the safe operating range of the PFC controller.



Figure 9. Using STATUS for PFC Shut-Down During Green Mode

Operating Mode Programming

Boundaries of the operating modes are programmed by the flyback transformer and the four components R_{PL} , R_{CS} , R_{OVP1} and R_{OVP2} ; shown in the Block Diagram/Application drawing.

The transformer characteristics that predominantly affect the modes are the magnetizing inductance of the primary and the magnitude of the output voltage, reflected to the primary. To a lesser degree (yet significant), the boundaries are affected by the MOSFET output capacitance and transformer leakage inductance. The design procedure here is to select a magnetizing inductance and a reflected output voltage that operates at the DCM/CCM boundary at maximum load and maximum line. The actual inductance should be noticeably smaller to account for the ring between the magnetizing inductance and the total stray capacitance measured at the drain of the power MOSFET. This programs the QR/DCM boundary of operation. All other mode boundaries are preset with the thresholds in the oscillator and green mode blocks.

The four components R_{PL} , R_{CS} , R_{OVP1} and R_{OVP2} must be programmed as a set due to the interactions of the functions. The use of the UCC28600 design calculator, TI Literature Number SLVC104, is highly reccomended in order to achieve the desired results with a careful balance between the transformer parameters and the programming resistors.

Protection Features

The UCC28600 has many protection features that are found only on larger, full featured controllers. Refer to the Block Diagram/Typical Application and Figures 1, 4, 5, 6 and 7 for detailed block descriptions that show how the features are integrated into the normal control functions.

Overtemperature

Overtemperature lockout typically occurs when the substrate temperature reaches 140°C. Retry is allowed if the substrate temperature reduces by the hysteresis value. Upon an overtemperature fault, C_{SS} on softstart is discharged and STATUS is forced to a high impedance.

Cycle-by-Cycle Power Limit

The cycle terminates when the CS voltage plus the power limit offset exceeds 0.8 V.

In order to have power limited over the full line voltage range of the QR Flyback converter, the CS pin voltage must have a component that is proportional to the primary current plus a component that is proportional to the line voltage due to predictable switching frequency variations due to line voltage. At power limit, the CS pin voltage plus the internal CS offset is compared against a constant 1.2-V reference in the PWM comparator. Thus during cycle-by-cycle power limit, the peak CS voltage is typically 0.8 V.

The current that is sourced from the OVP pin (I_{LINE}) is reflected to a dependent current source of ½ I_{LINE} , that is connected to the CS pin. The power limit function can be programmed by a resistor, R_{PL} , that is between the CS pin and the current sense resistor. The current, I_{LINE} , is proportional to line voltage by the transformer turns ratio N_B/N_P and resistor R_{OVP1} . Current I_{LINE} is programmed to set the line over voltage protection. Resistor R_{PL} results in the addition of a voltage to the current sense signal that is proportional to the line voltage. The proper amount of additional voltage has the effect of limiting the power on a cycle-by-cycle basis. Note that R_{CS} , R_{PL} , R_{OVP1} and R_{OVP2} must be adjusted as a set due to the functional interactions.

Current Limit

When the primary current exceeds maximum current level which is indicated by a voltage of 1.25 V at the CS pin, the device initiates a shutdown. Retry occurs after a UVLO_{OFF}/UVLO_{ON} cycle.

Over-Voltage Protection

Line and load over voltage protection is programmed with the transformer turn ratios, R_{OVP1} and R_{OVP2}. The OVP pin has a 0-V voltage source that can only source current; OVP cannot sink current.

Line over voltage protection occurs when the OVP pin is clamped at 0 V. When the bias winding is negative, during OUT = HI or portions of the resonant ring, the 0-V voltage source clamps OVP to 0 V and the current that is sourced from the OVP pin is mirrored to the Line_OVP comparator and the QR detection circuit. The Line_OVP comparator initiates a shutdown-retry sequence if OVP sources any more than 450 μ A.

Load-over voltage protection occurs when the OVP pin voltage is positive. When the bias winding is positive, during demagnetization or portions of the resonant ring, the OVP pin voltage is positive. If the OVP voltage is greater than 3.75 V, the device initiates a shutdown. Retry occurs after a UVLO_{OFF}/UVLO_{ON} cycle.

Undervoltage Lockout

Protection is provided to guard against operation during unfavorable bias conditions. Undervoltage lockout (UVLO) always monitors VDD to prevent operation below the UVLO threshold.





(2)

(3)

SLUS646B-NOVEMBER 2005-REVISED MAY 2006

PRACTICAL DESIGN NOTES

Non-Ideal Current Sense Value

Resistors R_{CS} , R_{PL} , R_{OVP1} and R_{OVP2} must be programmed as a set due to functional interactions in the converter. Often, the ideal value for R_{CS} is not available because the selection range of current sense resistors is too coarse to meet the required power limit tolerances. This issue can be solved by using the next larger available value of R_{CS} and use a resistive divider with a Thevenin resistance that is equal to the ideal R_{PL} value in order to attenuate the CS signal to its ideal value, as shown in Figure 14. The equations for modifying the circuit are:

$$R_{PL1} = R_{PL} \times \left(\frac{R_{CS}}{R_{DCS}}\right)$$

- R_{DCS} = ideal, but non-standard, value of current sense resistor.
- R_{PL} = previously calculated value of the power limit resistor.

$$R_{PL2} = \frac{R_{PL1}}{\left(\frac{R_{CS}}{R_{DCS}}\right) - 1}$$

• R_{CS} = available, standard value current sense resistor.

The board should be laid out to include R_{PL2} in order to fascillitate final optimization of the design based upon readily available components.



Figure 14. Modifications to Fit a Standard Current Sense Resistor Value

PRACTICAL DESIGN NOTES (continued)

Snubber Damping

Resonance between the leakage inductance and the MOSFET drain capacitance can cause false load-OVP faults, in spite of the typical 2-µs delay in load-OVP detection. The bias winding is sensitive to the overshoot and ringing because it is well coupled to the primary winding. A technique to eliminate the problem is to use an R²CD snubber instead of an RCD snubber, shown in Figure 15. A damping resistor added to the RCD snubber reduces ringing between the drain capacitor and the inductance when the snubber diode commutates OFF.





Figure 15. (a) RCD Snubber, (b) RCD Snubber Waveform, (c) R²CD Snubber, (d) R²CD Snubber Waveform

(4)

(9)

PRACTICAL DESIGN NOTES (continued)

Begin the design of the R²CD using the same procedure as designing an RCD snubber. Then, add the damping resistor, R_{SNUB2} . The procedure is as follows:

Pick
$$\frac{\Delta V_{SNUB}}{V_R}$$
 = between 0.5 and 1

Select a capacitor for ΔV_{SNUB} :

$$C_{SNUB} = \frac{I_{cs(peak)}^{2} L_{LEAK}}{\left(V_{R} + \Delta V_{SNUB}\right)^{2} - V_{R}^{2}}$$
(5)

Pick R_{SNUB} to discharge C_{SNUB}:

$$R_{SNUB1} = \left(\frac{1}{2} + \frac{V_R}{\Delta V_{SNUB}}\right) \frac{1}{C_{SNUB}} \left(\frac{1}{f_{S(max)}} - \frac{L_{LEAK}I_{CS(peak)}}{\Delta V_{SNUB}}\right)$$
(6)

$$P(R_{SNUB1}) = \frac{V_R}{R_{SNUB1}} + \frac{1}{2}I_{CS(peak)}^2 L_{LEAK} f_{S(max)}$$
(7)

Pick R_{SNUB2} to dampen the L_{LEAK} - C_{SNUB} resonance with a Q that is between 1.7 and 2.2:

$$R_{SNUB2} = \frac{\Delta V_{SNUB}}{I_{CS(peak)}}$$
(8)

$$P(R_{SNUB}) = I_{CS(peak)}^{2}R_{SNUB2} \left[\frac{1}{3} \frac{L_{LEAK}f_{S(max)}}{\left(V_{R} + \frac{\Delta V_{SNUB}}{2}\right)}\right]$$

For the original selection of ΔV_{SNUB} ,

$$Q = \sqrt{\frac{2V_R}{\Delta V_{SNUB}} + 1}$$
(10)

REFERENCES

- 1. Power Supply Seminar SEM-1400 Topic 2: *Design And Application Guide For High Speed MOSFET Gate Drive Circuits*, by Laszlo Balogh, Texas Instruments Literature Number SLUP133
- 2. Datasheet, UCC3581 Micro Power PWM Controller, Texas Instruments Literature Number SLUS295
- 3. Datasheet, UCC28051 Transition Mode PFC Controller, Texas Instruments Literature Number SLUS515
- 4. UCC28600 Design Calculator, A QR Flyback Designer.xls, spreadsheet for Microsoft Excel 2003, Texas Instruments Literature Number SLVC104

RELATED PRODUCTS

- UCC28051 Transition Mode PFC Controller (SLUS515)
- UCC3581 Micro Power PWM Controller (SLUS295)

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AA.



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